



### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

### **Product Summary**

Device	V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	l <sub>D</sub> max T <sub>A</sub> = +25°C
	Q1 20V	0.99Ω @ V <sub>GS</sub> = 4.5V	450mA
01		1.2Ω @ V <sub>GS</sub> = 2.5V	400mA
QI		1.8Ω @ V <sub>GS</sub> = 1.8V	330mA
		2.4Ω @ V <sub>GS</sub> = 1.5V	300mA
		1.9Ω @ V <sub>GS</sub> = -4.5V	-310mA
Q2	-20V	2.4Ω @ V <sub>GS</sub> = -2.5V	-280mA
QZ		3.4Ω @ V <sub>GS</sub> = -1.8V	-240mA
		5Ω @ V <sub>GS</sub> = -1.5V	-180mA

## Description

This MOSFET has been designed to minimize the on-state resistance  $(R_{DS(on)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

- General Purpose Interfacing Switch
- Power Management Functions
- Analog Switch



- Low On-Resistance
- Very low Gate Threshold Voltage, 1.0V max
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package 1mm x 1mm
- Low Package Profile, 0.45mm Maximum Package height
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3 & 4)
- Qualified to AEC-Q101 standards for High Reliability

## **Mechanical Data**

- Case: SOT963
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)

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Transistor Diagram

• Weight: 0.027 grams (approximate)



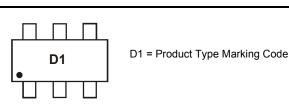
### Ordering Information (Note 5 & 6)

Part Number	Case	Packaging
DMC2990UDJ-7	SOT963	10K/Tape & Reel
DMC2990UDJ-7B	SOT963	10K/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.
- 5. The options -7 and -7B stand for different taping orientations. Please refer to Diodes website at http://www.diodes.com for further details.
- For packaging details, go to our website at http://www.diodes.com/products/packages.html

# Marking Information



DMC2990UDJ Document number: DS35481 Rev. 9 - 2



## Maximum Ratings Q1 N-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage			V <sub>DSS</sub>	20	V V
Gate-Source Voltage			V <sub>GSS</sub>	±8	
	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	450 350	mA
Continuous Drain Current (Note 7) $V_{GS}$ = 4.5V	t<5s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	520 410	mA
	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	330 260	mA
Continuous Drain Current (Note 7) $V_{GS}$ = 1.8V	t<5s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	390 310	mA
Maximum Continuous Body Diode Forward Currer		ls	440	mA	
Pulsed Drain Current (Note 8)		I <sub>DM</sub>	800	mA	

## Maximum Ratings Q2 P-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage			V <sub>DSS</sub>	-20	V V
Gate-Source Voltage			V <sub>GSS</sub>	±8	
	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	-310 -240	mA
Continuous Drain Current (Note 5) $V_{GS}$ = -4.5V	t<5s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	Ι <sub>D</sub>	-360 -280	mA
	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	Ι <sub>D</sub>	-240 -190	mA
Continuous Drain Current (Note 5) $V_{GS}$ = -1.8V	t<5s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	I <sub>D</sub>	-280 -220	mA
Maximum Continuous Body Diode Forward Curren		Is	-440	mA	
Pulsed Drain Current (Note 8)			I <sub>DM</sub>	-800	mA

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 7)		PD	350	mW
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Devi	360	°C/W
	t<5s	R <sub>0JA</sub>	270	°C/W
Operating and Storage Temperature Range		$T_{J,} T_{STG}$	-55 to +150	°C

Notes:

Device mounted on FR-4 PCB, with minimum recommended pad layout.
 Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.



## Electrical Characteristics Q1 N-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)	Cymbol		194	max	onit	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$
		-	-	100	nA	V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$	IDSS	-	-	50		V <sub>DS</sub> = 5V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±100	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)			_			
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.4	-	1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
		-	0.60	0.99		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 100mA
		-	0.75	1.2		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 50mA
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	0.90	1.8	Ω	V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 20mA
	- ( - )	-	1.2	2.4		V <sub>GS</sub> = 1.5V, I <sub>D</sub> = 10mA
		-	2.0	-		V <sub>GS</sub> = 1.2V, I <sub>D</sub> = 1mA
Forward Transfer Admittance		180	850	-	mS	V <sub>DS</sub> = 5V, I <sub>D</sub> = 125mA
Diode Forward Voltage		-	0.6	1.0	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 10mA
DYNAMIC CHARACTERISTICS (Note 10)						•
Input Capacitance		-	27.6	-	pF	
Output Capacitance		-	4.0	-	pF	−V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, −f = 1.0MHz
Reverse Transfer Capacitance	C <sub>oss</sub> C <sub>rss</sub>	-	2.8	-	pF	1 - 1:00012
Gate Resistance	$R_{G}$	-	113	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	Qg	-	0.5	-	nC	V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 10V,
Gate-Source Charge		-	0.07	-	nC	I <sub>D</sub> = 250mA
Gate-Drain Charge	Q <sub>gd</sub>	-	0.07	-	nC	
Turn-On Delay Time	t <sub>D(on)</sub>	-	4.0	-	ns	
Turn-On Rise Time	tr	-	3.3	-	ns	$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t <sub>D(off)</sub>	-	19.0	-	ns	$R_{L} = 47\Omega, R_{G} = 2\Omega,$ $I_{D} = 200 \text{mA}$
Turn-Off Fall Time	t <sub>f</sub>	-	6.4	-	ns	

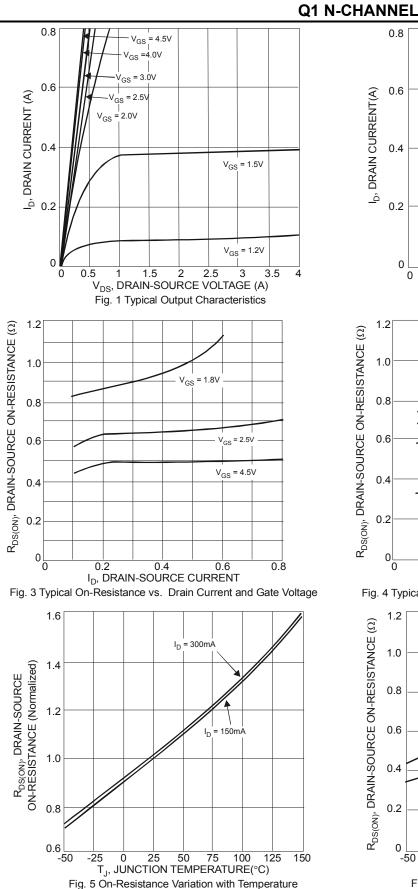
## Electrical Characteristics Q2 P-CHANNEL (@T<sub>A</sub> = +25°C, unless otherwise specified.)

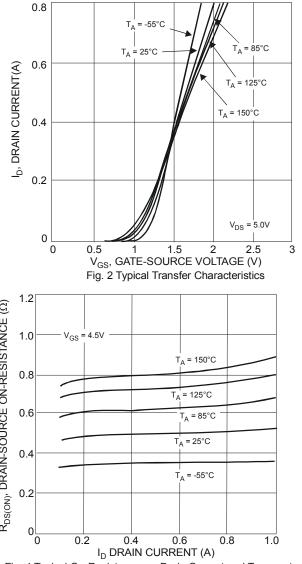
Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
	°C 1	-	-	100	nA	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V	
Zero Gate Voltage Drain Current $@T_C = +25$	°C I <sub>DSS</sub>	-	-	50		$V_{DS}$ = -5V, $V_{GS}$ = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±100	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.4	-	-1.0	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	
		-	1.2	1.9		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -100mA	
		-	1.5	2.4		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -50mA	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	2.1	3.4	Ω	V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -20mA	
		-	2.5	5		V <sub>GS</sub> = -1.5V, I <sub>D</sub> = -10mA	
		-	4.0	-		V <sub>GS</sub> = -1.2V, I <sub>D</sub> = -1mA	
Forward Transfer Admittance		100	450	-	mS	V <sub>DS</sub> = -5V, I <sub>D</sub> = -125mA	
Diode Forward Voltage	V <sub>SD</sub>	-	-0.6	-1.0	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -10mA	
DYNAMIC CHARACTERISTICS (Note 10)						÷	
Input Capacitance	Ciss	-	28.7	-	pF		
Output Capacitance	Coss	-	4.2	-	pF	V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	2.9	-	pF	1 - 1:000112	
Gate Resistance	R <sub>G</sub>	-	399	-	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Total Gate Charge	Qg	-	0.4	-	nC		
Gate-Source Charge	Q <sub>gs</sub>	-	0.08	-	nC	−V <sub>GS</sub> = -4.5V, V <sub>DS</sub> =- 10V, −I <sub>D</sub> = -250mA	
Gate-Drain Charge	Q <sub>gd</sub>	-	0.06	-	nC	$I_D = -250 \text{IIA}$	
Turn-On Delay Time	t <sub>D(on)</sub>	-	5.8	-	ns		
Turn-On Rise Time	tr	-	5.7	-	ns	V <sub>DD</sub> = -15V, V <sub>GS</sub> = -4.5V,	
Turn-Off Delay Time	t <sub>D(off)</sub>	-	31.1	-	ns	$R_{G} = 2\Omega, I_{D} = -200 \text{mA}$	
Turn-Off Fall Time	tf	-	16.4	-	ns	1	

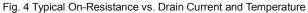
Notes: 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.

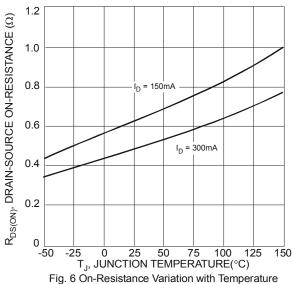


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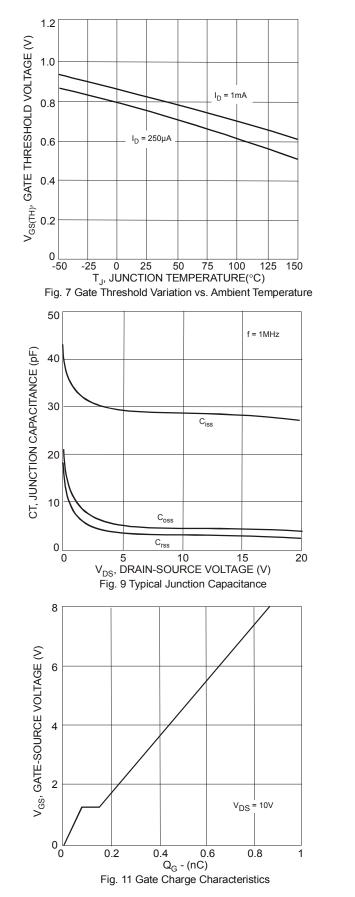


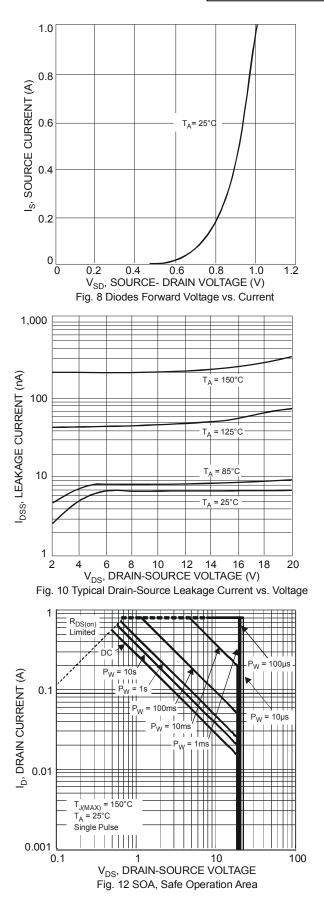






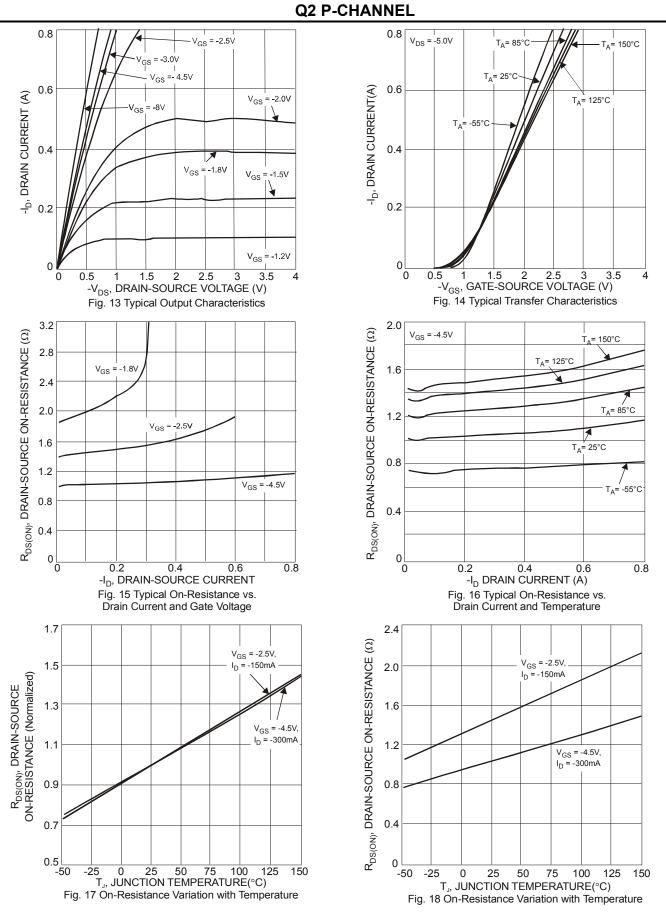
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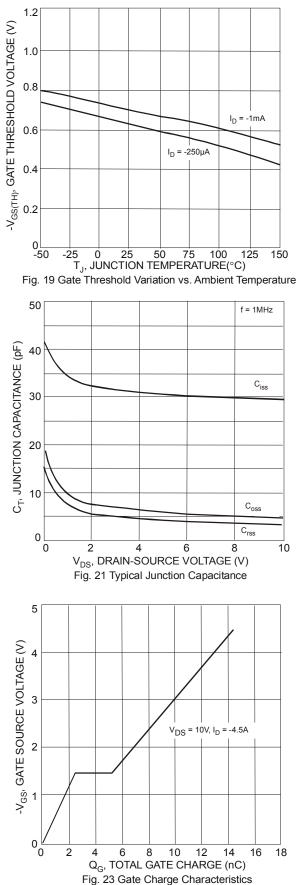


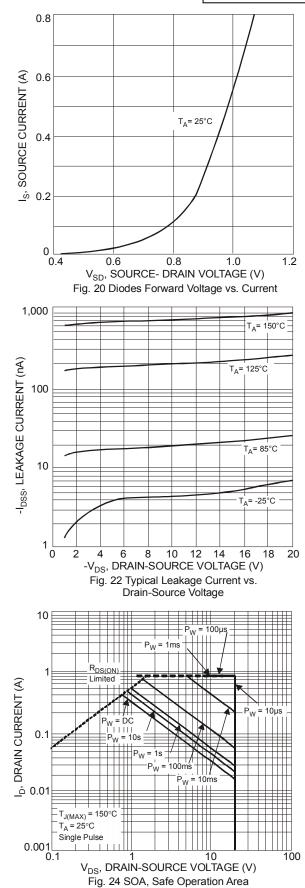
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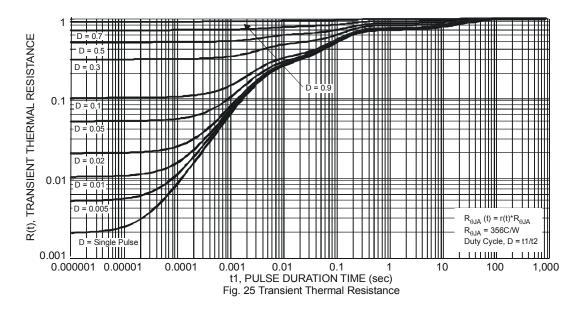




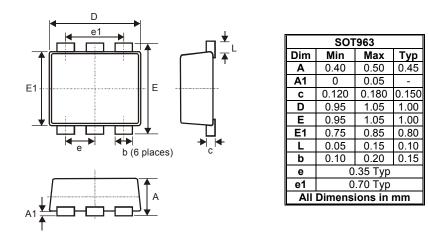




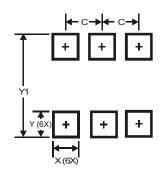




## Package Outline Dimensions



## Suggested Pad Layout



Dimensions	Value (in mm)
С	0.350
Х	0.200
Y	0.200
Y1	1.100



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